# imall

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October 2001



### **FDS6898AZ**

### Dual N-Channel Logic Level PWM Optimized PowerTrench<sup>®</sup> MOSFET

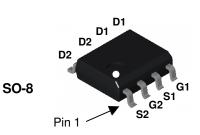
#### **General Description**

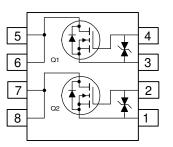
These N-Channel Logic Level MOSFETs are produced Fairchild using Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

#### **Features**

- $R_{\text{DS(ON)}}$  = 14 m $\Omega$  @ V\_{GS} = 4.5 V • 9.4 A, 20 V  $R_{DS(ON)}$  = 18 m $\Omega$  @ V<sub>GS</sub> = 2.5 V
- Low gate charge (16 nC typical)
- ESD protection diode (note 3)
- High performance trench technology for extremely low R<sub>DS(ON)</sub>
- · High power and current handling capability





#### Absolute Maximum Ratings T<sub>A=25°C unless otherwise noted</sub>

Symbol	Parameter			Ratings	Units	
V <sub>DSS</sub>	Drain-Sour	ce Voltage		20	V	
V <sub>GSS</sub>	Gate-Source	e Voltage		± 12	V	
I <sub>D</sub>	Drain Curre	ent – Continuous	(Note 1a)	9.4	А	
		– Pulsed		38		
PD	Power Dissipation for Dual Operation			2	W	
	Power Diss	ipation for Single Operat	tion (Note 1a)	1.6		
			(Note 1b)	1		
			(Note 1c)	0.9		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	
Therma	l Charac	teristics				
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)			78	°C/W	
R <sub>eJC</sub>	Thermal Resistance, Junction-to-Case (N			40	°C/W	
Packag	e Markin	g and Ordering	Information			
Device Marking		Device	Reel Size	Tape width	Quantity	

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6898AZ	FDS6898AZ	13"	12mm	2500 units
	•	-	•	

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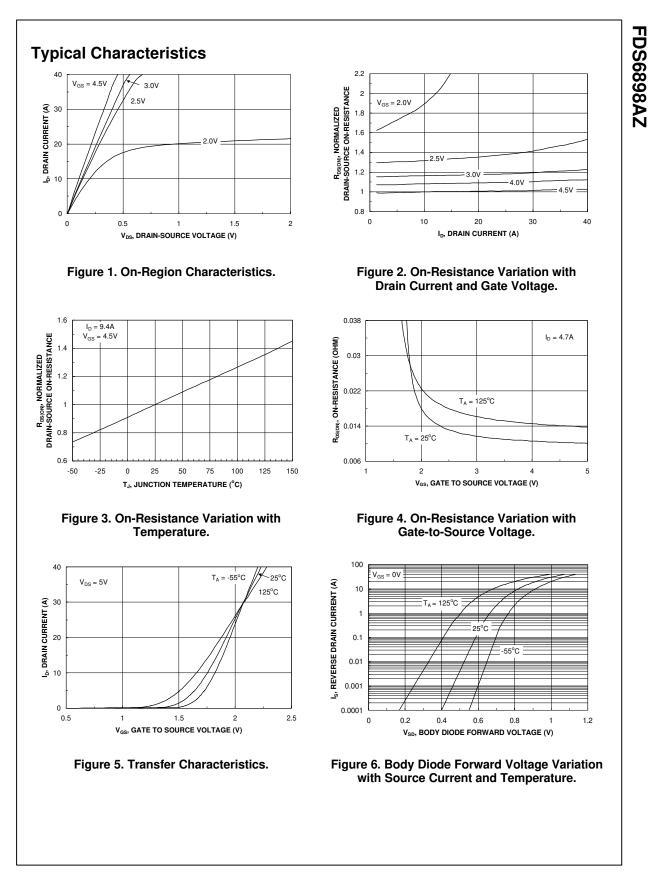
FDS6898AZ

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	racteristics			1		
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	20			V
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, Referenced to 25°C		21		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 16 V$ , $V_{GS} = 0 V$			1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 12 \text{ V},  V_{DS} = 0 \text{ V}$			10	μA
I <sub>GSSR</sub>	Gate-Body Leakage, Reverse	$V_{GS} = -12 V$ , $V_{DS} = 0 V$			-10	μA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.5	1	1.5	V
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-3.5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS}=4.5 \ V, \ I_{D}=9.4 \ A \\ V_{GS}=2.5 \ V, \ I_{D}=8.3 \ A \\ V_{GS}=4.5 \ V, \ I_{D}=9.4 \ A, \\ T_{J}=125^{\circ}C \end{array} $		10 13 14	14 18 21	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 4.5V, \qquad V_{DS} = 5~V$	19			Α
<b>g</b> fs	Forward Transconductance $V_{DS} = 5 V$ , $I_D = 9.4 A$			47		S
Dynamic	c Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 10 V$ , $V_{GS} = 0 V$ ,		1821		pF
Coss	Output Capacitance	f = 1.0 MHz		440		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			208		pF
Switchir	ng Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = 10 \text{ V}, \qquad I_D = 1 \text{ A},$		10	20	ns
tr	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V},  R_{GEN} = 6 \Omega$		15	27	ns
d(off)	Turn–Off Delay Time			34	55	ns
f	Turn–Off Fall Time			16	29	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = 10 \text{ V},  I_D = 9.4 \text{ A},$		16	23	nC
Q <sub>qs</sub>	Gate-Source Charge	$V_{GS} = 4.5 V$		3		nC
Q <sub>gd</sub>	Gate-Drain Charge			4		nC
	ource Diode Characteristics a	and Maximum Batings		1		
l <sub>s</sub>	Maximum Continuous Drain–Source				1.3	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \ V,  I_S = 1.3 \ A$ (Note 2)		0.7	1.2	V

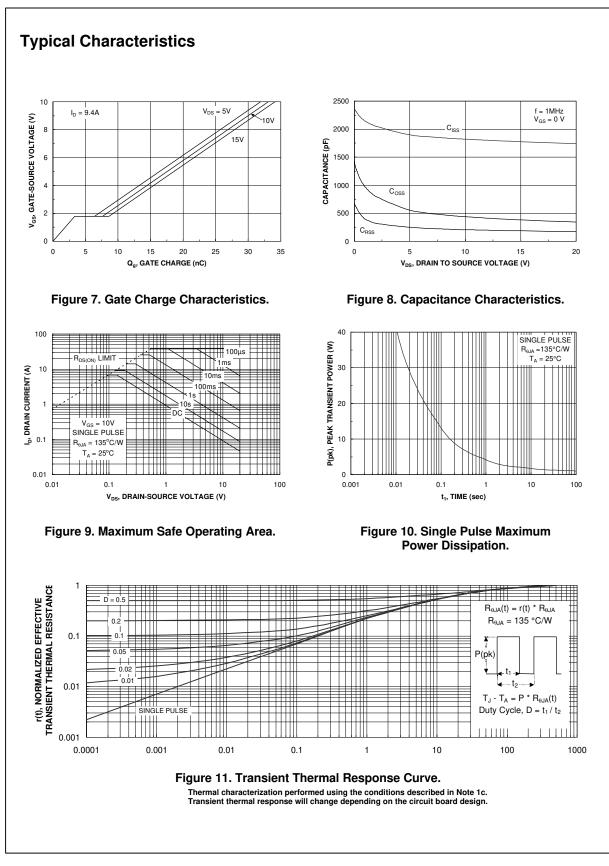
0000 Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 $\mu s,$  Duty Cycle < 2.0%

3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied



FDS6898AZ Rev C (W)



FDS6898AZ Rev C (W)

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	Formative or In Design First Production Full Production

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